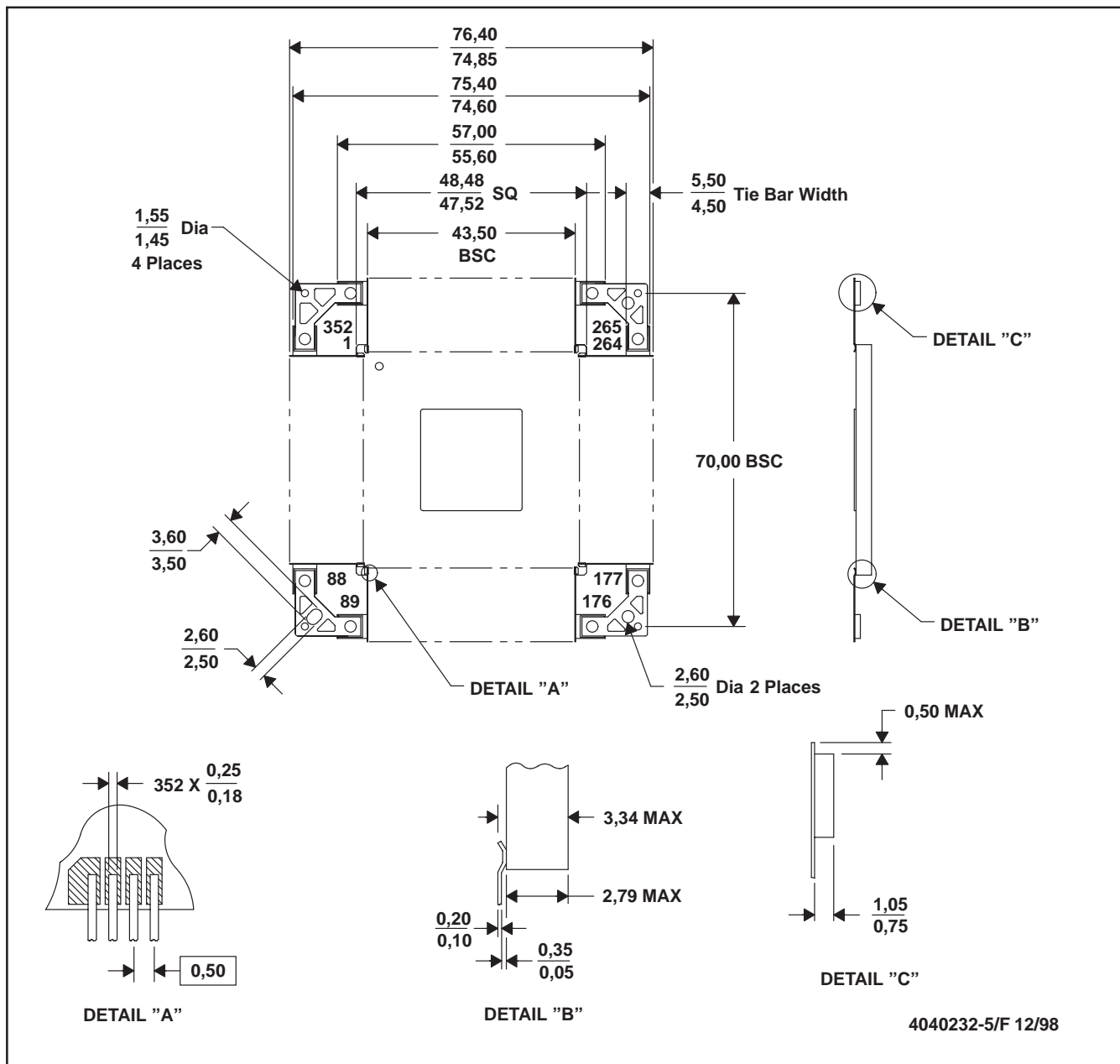


HFH (R-CQFP-F352)

CERAMIC QUAD FLATPACK WITH NCTB



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. This package is hermetically sealed with a metal lid.
  - D. The terminals are gold-plated.
  - E. Leads not shown for clarity purposes
  - F. Falls within JEDEC MO-134AE

4040232-5/F 12/98

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